



Two-Photon-Absorption-Induced Carrier Generation: Calibration, Modeling, and Experimental Validation

Dale McMorrow¹, Joel M. Hales², Ani Khachatrian², Stephen P. Buchner¹, Jeffrey H. Warner¹, Nicolas Roche³, Adrian Iledfonso⁴, Zachary E. Fleetwood⁴, and John D. Cressler⁴

¹Naval Research Laboratory, Washington, DC
²Sotera Defense, Annapolis Junction, MD
³University of Montpellier, Montpellier, FR
⁴Georgia Institute of Technology, Atlanta, GA

This work is supported by the Defense Threat Reduction Agency and the Office of Naval Research





- Background
 - TPA Dosimetry
 - Modeling Carrier Generation
- Experimental Validation of NLOBPM Model
- Laser/Ion Comparison
- Challenges Moving Forward





Advantages and Applications of PLSEE

Pulsed-laser SEE is used for:

- Sensitive Node Identification/Mitigation
- SEU Mapping of sensitive areas
- Laser-Induced Latch-up Screening/Mitigation
- Single-Event Transient Characterization and Mitigation
- Single-Event Transient Screening (ASETs)
- Hardened Circuit Verification
- Dynamic SEE Testing
- Experimental Test Setup Verification
- Basic Mechanisms Studies

Recent Challenges: Quantitative Characterization of TPA SEE

S NAV

RATORY







- Dosimetry methodology for TPA SEE developed, implemented, and verified
- Three online beam monitors
 - Laser pulse energy
 - Laser pulse width
 - Focused spot size





TPA Dosimetry



Khachatrian, et al., "A Dosimetry Method for Two-Photon Absorption Induced Single-Event Effects Measurements," IEEE TNS December 2014.





TPA Dosimetry – Summary

- Dosimetry methodology for TPA SEE developed, implemented, and verified
- Three online beam monitors
 - Laser pulse energy
 - Laser pulse width
 - Focused spot size
- Capabilities:
 - Monitor and correct fluctuations in laser system operating point
 - Set system to predefined operating point
 - Correlation of different experiments





What Happens Inside the Silicon?

- Need exists for understanding *quantitatively* the carrier density distribution in TPA SEE experiments
 - Complicated problem
- Community has been relying on a *"Zeroth Order"* representation
 - Only considers carrier generation
 - Neglects all all other effects
- NRL has initiated a program to address this problem



McMorrow, et. al, TNS 49, 3002 (2002).





Goals:

- Produce a software program that can accurately simulate the TPA-induced carrier deposition profile in silicon for any given set of experimental conditions (Practical Goal)
- Simulate/predict impact of various optical nonlinearities on the beam propagation through, and generation of free carriers in the medium (Scientific Goal)
- Validate results through experimental measurement

<u>Approach:</u>

Numerical modeling using existing simulation software (*NLO-BPM*) adapted for carrier generation and applied to silicon [Kovsh, et al., Applied Optics, 38, 1568 (1999)]

[Hales, et al., IEEE TNS, 62, 1-8 (2015)]



Hales, et al., TNS 2015



Experimental Validation



Hales, et al., TNS 2015





SiO₂ and P-glass

n⁺ contacts

depletion region

p-Type epi layer

p⁺ Substrate

back contact

metal

n⁺ area



Observable: Charge-collection transient

"Z" Dependence of collected charge



RPP and Depth Profiles



- **RPP model** used to estimate collected charge
 - Preliminary collaborative TCAD analysis with Robust Chip Inc. shows good correlation with RPP model for bulk diode
- "CC z-scans" depth profiles of integrated/collected charge as a function of axial or "z" position of focus – can be generated





Experimental Geometries - TPA



Dosimeter DUT: 100x



Centronic Bulk Si Diode





RPP depth of 66 μ m >> charge profile size



Centronic Bulk Si Diode





- Diode studied extensively via both TPA and SPA; detector used for dosimeter
- Magnitudes, positions, trends of z-scans show good agreement
- Simulations narrower/more symmetric than experimental data; oversimplification of RPP?





Simulation consistently overestimates CC



Impact of Surface Reflections



- Sims consistently overestimate CC
- Previously assumed perfect AR coating (R=0%)
- Communication with Centronic yielded specific information on SiO₂ AR coating and then calculated dispersion of reflectance
- Significant reflectance found at all wavelengths





Impact of Surface Reflections









Measurements taken over 2.5 year time frame using multiple focusing configurations

Correlation Study: Sandia n+/p/p+ Epitaxial Diode





RPP depth of 2.3 μ *m << charge profile size*





Correlation Study: Sandia n+/p/p+ Epitaxial Diode



- Well-defined charge collection depth
- Overall magnitudes, positions, trends of z-scans show good agreement
- Narrower scans peaked closer to z = 0 are reproduced by simulations





Correlation Study: Sandia n+/p/p+ Epitaxial Diode









- Simple analytic equations for SPA charge deposition allow for error analysis
- Horizontal error bars show systematic error in Q_z (13%), vertical error bars show random error in CC values (10%)
- \circ Total error (± 16%, red lines) encompasses both
- Measurements from different sites with different charge distributions all lie within confidence intervals given by the total error

SPA Data from: Buchner, IEEE TNS, 59, 988 (2012)



Laser-Ion Correlation - SPA



SPA Data from: Buchner, IEEE TNS, 59, 988 (2012)



Laser-Ion Correlation - SPA





Data from: Buchner, IEEE TNS, 59, 988 (2012)



Laser-Ion Correlation - TPA





Laser-Ion Correlation - TPA



Hales, et al., Presented at RADECS 2017





- Validation of NLOBPM with experimental data continues
 - Quantitative agreement with experimental observables
 - NLOBPM code is performing as hoped
- Current Challenges/In Progress
 - Integration with device simulators (TCAD)
 - Application to more complex device structures
- Laser/Ion comparison is progressing
- Recent results (not presented)
 - GaAs Diode
 - GaN Diode
 - SiGe Diode
 - SiGe HBT
 - GF 32 nm PD SOI NFET
 - Analytical equations for integral CC (TPA and SPA)